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REVISION HISTORY

7/12—Revision 0: Initial Version

SPECIFICATIONS

$V_{POS} = 5\text{ V}$, $C_{LFP} = 220\text{ pF}$, $T_A = 25^\circ\text{C}$, $52.3\ \Omega$ termination resistor at INHI, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
SIGNAL INPUT INTERFACE	INHI (Pin 14) and INLO (Pin 15)				
Specified Frequency Range		0.001		8	GHz
DC Common-Mode Voltage			$V_{POS} - 1.8$		V
MEASUREMENT MODE	VOUT (Pin 6) shorted to VSET (Pin 7), sinusoidal input signal $R_{TADJ} = 500\ \Omega$				
$f = 900\text{ MHz}$					
Input Impedance	$T_A = 25^\circ\text{C}$		957 0.71		ΩpF
$\pm 3\text{ dB Dynamic Range}$	$-55^\circ\text{C} < T_A < +105^\circ\text{C}$		65		dB
	$T_A = 25^\circ\text{C}$		63		dB
$\pm 1\text{ dB Dynamic Range}$	$T_A = 25^\circ\text{C}$		57		dB
Maximum Input Level	$\pm 1\text{ dB error}$		-1		dBm
Minimum Input Level	$\pm 1\text{ dB error}$		-58		dBm
Slope		-26	-24.5	-23	mV/dB
Intercept		19.5	22	24	dBm
Output Voltage—High Power In	$P_{IN} = -10\text{ dBm}$	0.7	0.78	0.86	V
Output Voltage—Low Power In	$P_{IN} = -40\text{ dBm}$	1.42	1.52	1.62	V
Temperature Sensitivity	$P_{IN} = -10\text{ dBm}$ $25^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$		0.0071		dB/°C
	$-55^\circ\text{C} \leq T_A \leq +25^\circ\text{C}$		0.0031		dB/°C
$f = 1.9\text{ GHz}$	$R_{TADJ} = 500\ \Omega$				
Input Impedance	$T_A = 25^\circ\text{C}$		523 0.68		ΩpF
$\pm 3\text{ dB Dynamic Range}$	$-55^\circ\text{C} < T_A < +105^\circ\text{C}$		65		dB
	$T_A = 25^\circ\text{C}$		63		dB
$\pm 1\text{ dB Dynamic Range}$	$T_A = 25^\circ\text{C}$		57		dB
Maximum Input Level	$\pm 1\text{ dB error}$		-2		dBm
Minimum Input Level	$\pm 1\text{ dB error}$		-59		dBm
Slope		-27	-24.4	-22	mV/dB
Intercept		17	20.4	24	dBm
Output Voltage—High Power In	$P_{IN} = -10\text{ dBm}$	0.63	0.73	0.83	V
Output Voltage—Low Power In	$P_{IN} = -35\text{ dBm}$	1.2	1.35	1.5	V
Temperature Sensitivity	$P_{IN} = -10\text{ dBm}$ $25^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$		0.0056		dB/°C
	$-55^\circ\text{C} \leq T_A \leq +25^\circ\text{C}$		0.0004		dB/°C
$f = 2.2\text{ GHz}$	$R_{TADJ} = 500\ \Omega$				
Input Impedance	$T_A = 25^\circ\text{C}$		391 0.66		ΩpF
$\pm 3\text{ dB Dynamic Range}$	$-55^\circ\text{C} < T_A < +105^\circ\text{C}$		65		dB
	$T_A = 25^\circ\text{C}$		62		dB
$\pm 1\text{ dB Dynamic Range}$	$T_A = 25^\circ\text{C}$		58		dB
Maximum Input Level	$\pm 1\text{ dB error}$		-2		dBm
Minimum Input Level	$\pm 1\text{ dB error}$		-60		dBm
Slope		-28	-24.4	-21.5	mV/dB
Intercept		15	19.6	25	dBm
Output Voltage—High Power In	$P_{IN} = -10\text{ dBm}$	0.63	0.73	0.84	V
Output Voltage—Low Power In	$P_{IN} = -35\text{ dBm}$	1.2	1.34	1.5	V
Temperature Sensitivity	$P_{IN} = -10\text{ dBm}$ $25^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$		0.0052		dB/°C
	$-55^\circ\text{C} \leq T_A \leq +25^\circ\text{C}$		0.0034		dB/°C

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
f = 3.6 GHz	$R_{TADJ} = 51 \Omega$				
Input Impedance			119 0.7		ΩpF
±3 dB Dynamic Range	$T_A = 25^\circ C$		70		dB
	$-55^\circ C < T_A < +105^\circ C$		61		dB
±1 dB Dynamic Range	$T_A = 25^\circ C$		58		dB
Maximum Input Level	±1 dB error		-2		dBm
Minimum Input Level	±1 dB error		-60		dBm
Slope			-24.3		mV/dB
Intercept			19.8		dBm
Output Voltage—High Power In	$P_{IN} = -10 \text{ dBm}$		0.717		V
Output Voltage—Low Power In	$P_{IN} = -40 \text{ dBm}$		1.46		V
Temperature Sensitivity	$P_{IN} = -10 \text{ dBm}$				
	$25^\circ C \leq T_A \leq 105^\circ C$		0.0012		dB/°C
	$-55^\circ C \leq T_A \leq +25^\circ C$		0.009		dB/°C
f = 5.8 GHz	$R_{TADJ} = 1000 \Omega$				
Input Impedance			33 0.59		ΩpF
±3 dB Dynamic Range	$T_A = 25^\circ C$		70		dB
	$-55^\circ C < T_A < +105^\circ C$		62		dB
±1 dB Dynamic Range	$T_A = 25^\circ C$		57		dB
Maximum Input Level	±1 dB error		-1		dBm
Minimum Input Level	±1 dB error		-58		dBm
Slope			-24.3		mV/dB
Intercept			25		dBm
Output Voltage—High Power In	$P_{IN} = -10 \text{ dBm}$		0.86		V
Output Voltage—Low Power In	$P_{IN} = -40 \text{ dBm}$		1.59		V
Temperature Sensitivity	$P_{IN} = -10 \text{ dBm}$				
	$25^\circ C \leq T_A \leq 105^\circ C$		0.019		dB/°C
	$-55^\circ C \leq T_A \leq +25^\circ C$		0.0096		dB/°C
f = 8.0 GHz	$R_{TADJ} = 500 \Omega$				
±3 dB Dynamic Range	$T_A = 25^\circ C$		60		dB
	$-55^\circ C < T_A < +105^\circ C$		58		dB
Maximum Input Level	±3 dB error		3		dBm
Minimum Input Level	±3 dB error		-55		dBm
Slope			-23		mV/dB
Intercept			37		dBm
Output Voltage—High Power In	$P_{IN} = -10 \text{ dBm}$		1.06		V
Output Voltage—Low Power In	$P_{IN} = -40 \text{ dBm}$		1.78		V
Temperature Sensitivity	$P_{IN} = -10 \text{ dBm}$				
	$25^\circ C \leq T_A \leq 105^\circ C$		0.032		dB/°C
	$-55^\circ C \leq T_A \leq +25^\circ C$		0.0078		dB/°C
OUTPUT INTERFACE	VOUT (Pin 6)				
Voltage Swing	$V_{SET} = 0 \text{ V}; P_{IN} = -10 \text{ dBm}$, no load ¹		4.9		V
	$V_{SET} = 2.1 \text{ V}; P_{IN} = -10 \text{ dBm}$, no load ¹		25		mV
Output Current Drive	$V_{SET} = 1.5 \text{ V}; P_{IN} = -50 \text{ dBm}$		60		mA
Small Signal Bandwidth	$P_{IN} = -10 \text{ dBm}$; from CLPF to VOUT		60		MHz
Video Bandwidth (or Envelope Bandwidth)			45		MHz
Output Noise	$P_{IN} = 2.2 \text{ GHz}; -10 \text{ dBm}$, $f_{NOISE} = 100 \text{ kHz}$, $C_{LPF} = 220 \text{ pF}$		90		nV/ $\sqrt{\text{Hz}}$
Fall Time	$P_{IN} = \text{Off to } -10 \text{ dBm}$, 90% to 10%		10		ns
Rise Time	$P_{IN} = -10 \text{ dBm}$ to off, 10% to 90%		12		ns

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
VSET INTERFACE	VSET (Pin 7)				
Nominal Input Range	$P_{IN} = 0 \text{ dBm}$; measurement mode ² $P_{IN} = -65 \text{ dBm}$; measurement mode ²		0.5 2.1		V
Logarithmic Scale Factor			-0.04		dB/mV
Bias Current Source	$P_{IN} = -10 \text{ dBm}$; $V_{SET} = 2.1 \text{ V}$		2.5		μA
TEMPERATURE REFERENCE	TEMP (Pin 13)				
Output Voltage	$T_A = 25^\circ\text{C}$, $R_{LOAD} = 10 \text{ k}\Omega$	0.57	0.6	0.63	V
Temperature Slope	$-55^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$, $R_{LOAD} = 10 \text{ k}\Omega$		2		mV/ $^\circ\text{C}$
Current Source/Sink	$T_A = 25^\circ\text{C}$		10/0.1		mA
POWER-DOWN INTERFACE	ENBL (Pin 16)				
Logic Level to Enable Device			1.7		V
ENBL Current When Enabled	ENBL = 5 V		<1		μA
ENBL Current When Disabled	ENBL = 0 V; sourcing		15		μA
POWER INTERFACE	VPSI (Pin 3 and Pin 4), VPSO (Pin 9)				
Supply Voltage		4.5	5	5.5	V
Quiescent Current	ENBL = 5 V	50	68	82	mA
vs. Temperature	$-55^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$		150		$\mu\text{A}/^\circ\text{C}$
Supply Current when Disabled	ENBL = 0 V, total currents for VPSI and VPSO		260		μA
vs. Temperature	$-55^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$		350		μA

¹ Controller mode.² Gain = 1. For other gains, see the [AD8318](#) data sheet.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage: Pin VPSO, Pin VPSI	5.7 V
ENBL, V_{SET} Voltage	0 to V_{POS}
Input Power (Single-Ended, re: 50 Ω)	12 dBm
Internal Power Dissipation	0.73 W
θ_{JA} ¹	55°C/W
Maximum Junction Temperature	130°C
Operating Temperature Range	–55°C to +105°C
Storage Temperature Range	–65°C to +150°C

¹ With package die paddle soldered to thermal pads with vias connecting to inner and bottom layers.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

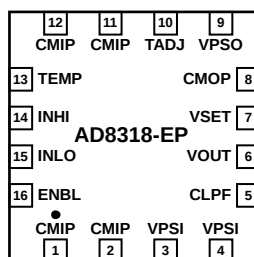
ESD CAUTION



ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES
1. THE EXPOSED PADDLE IS INTERNALLY CONNECTED TO CMIP (SOLDER TO GROUND).

10783-002

Figure 3. Pin Configuration

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1, 2, 11, 12	CMIP	Device Common (Input System Ground).
3, 4	VPSI	Positive Supply Voltage (Input System): 4.5 V to 5.5 V. Voltage on Pin 3, Pin 4, and Pin 9 should be equal.
5	CLPF	Loop Filter Capacitor.
6	VOUT	Measurement and Controller Output.
7	VSET	Setpoint Input for Controller Mode or Feedback Input for Measurement Mode.
8	CMOP	Device Common (Output System Ground).
9	VPSO	Positive Supply Voltage (Output System): 4.5 V to 5.5 V. Voltage on Pin 3, Pin 4, and Pin 9 should be equal.
10	TADJ	Temperature Compensation Adjustment.
13	TEMP	Temperature Sensor Output.
14	INHI	RF Input. Nominal input range: -60 dBm to 0 dBm (re: 50 Ω), ac-coupled.
15	INLO	RF Common for INHI. AC-coupled RF common.
16	ENBL	Device Enable. Connect to VPSI for normal operation. Connect pin to ground for disable mode.
	Paddle	The Exposed Paddle is Internally Connected to CMIP (Solder to Ground).

TYPICAL PERFORMANCE CHARACTERISTICS

$V_{POS} = 5\text{ V}$; $T_A = +25^\circ\text{C}$, -55°C , $+105^\circ\text{C}$; $C_{LPF} = 220\text{ pF}$; $R_{TADJ} = 500\ \Omega$; unless otherwise noted. Colors: $+25^\circ\text{C} \rightarrow$ Black; $-55^\circ\text{C} \rightarrow$ Blue; $+105^\circ\text{C} \rightarrow$ Red.

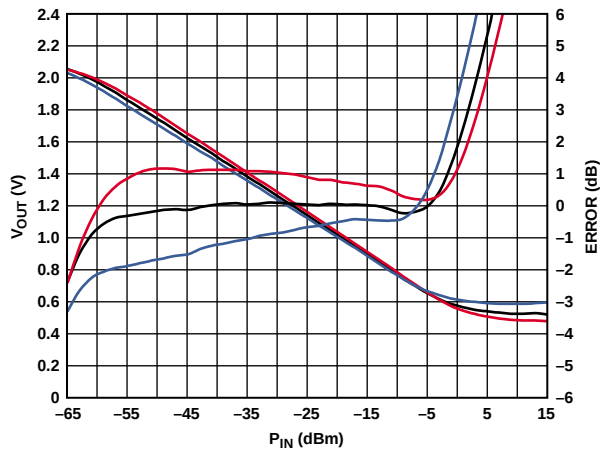


Figure 4. V_{OUT} and Log Conformance vs. Input Amplitude at 900 MHz, Typical Device

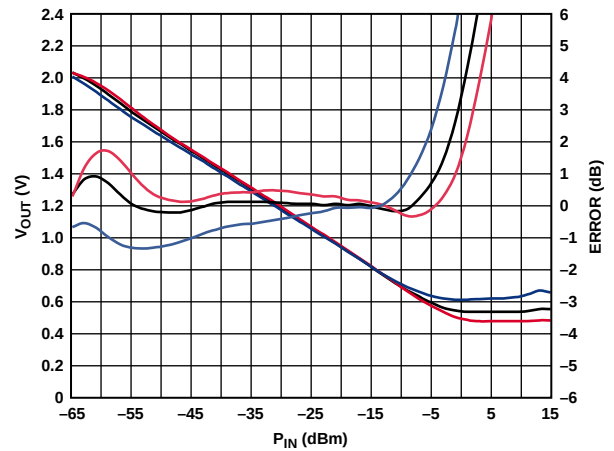


Figure 7. V_{OUT} and Log Conformance vs. Input Amplitude at 3.6 GHz, Typical Device, $R_{TADJ} = 51\ \Omega$

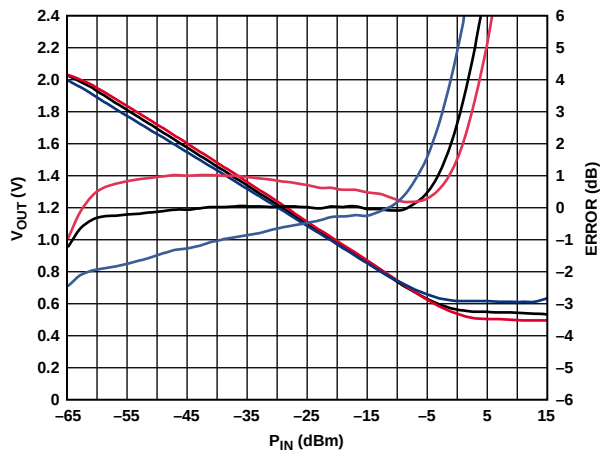


Figure 5. V_{OUT} and Log Conformance vs. Input Amplitude at 1.9 GHz, Typical Device

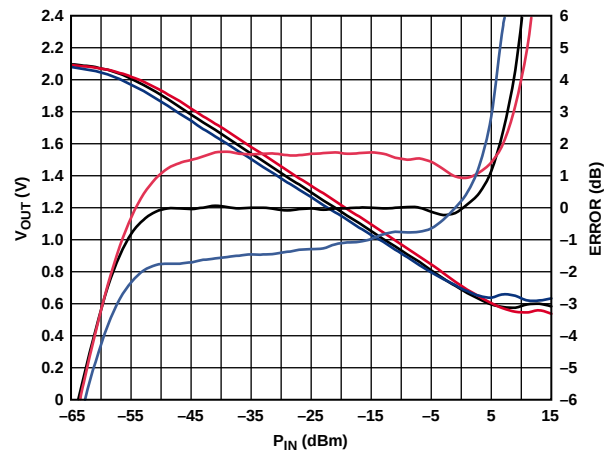


Figure 8. V_{OUT} and Log Conformance vs. Input Amplitude at 5.8 GHz, Typical Device, $R_{TADJ} = 1000\ \Omega$

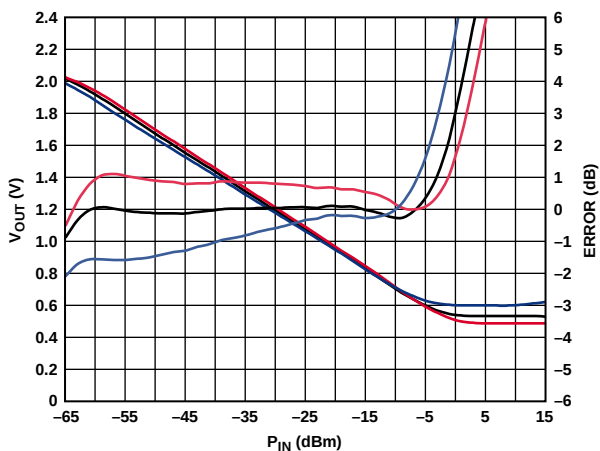


Figure 6. V_{OUT} and Log Conformance vs. Input Amplitude at 2.2 GHz, Typical Device

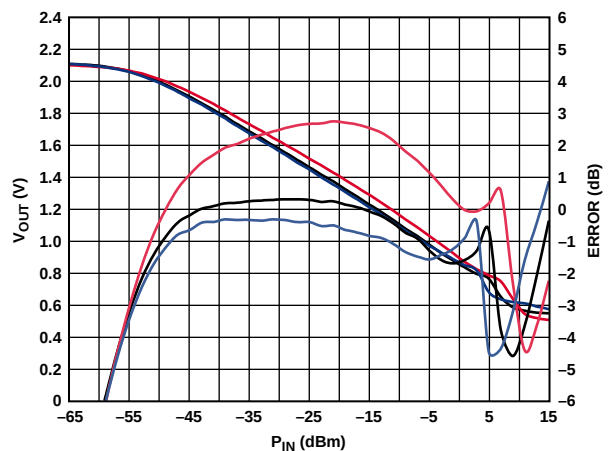


Figure 9. V_{OUT} and Log Conformance vs. Input Amplitude at 8 GHz, Typical Device

$V_{POS} = 5\text{ V}$; $T_A = +25^\circ\text{C}$, -55°C , $+105^\circ\text{C}$; $C_{LPF} = 220\text{ pF}$; $R_{TADJ} = 500\ \Omega$; unless otherwise noted. Colors: $+25^\circ\text{C} \rightarrow$ Black; $-55^\circ\text{C} \rightarrow$ Blue; $+105^\circ\text{C} \rightarrow$ Red.

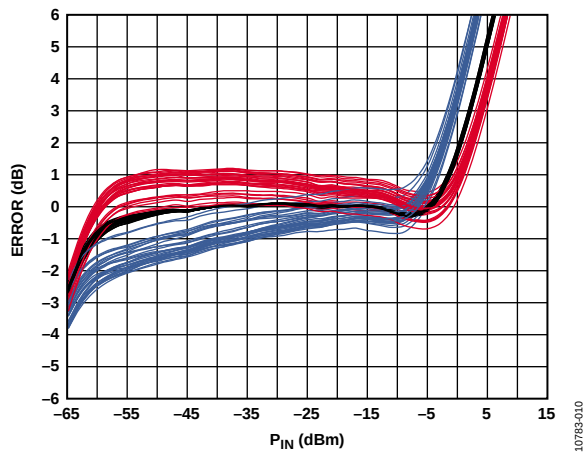


Figure 10. Distribution of Error over Temperature After Ambient Normalization vs. Input Amplitude at 900 MHz for at Least 70 Devices

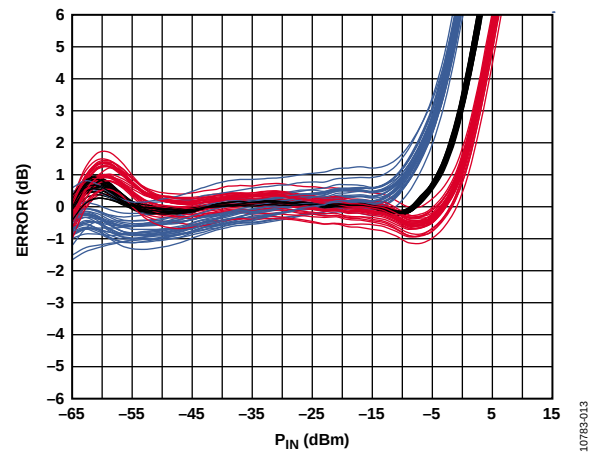


Figure 13. Distribution of Error at Temperature After Ambient Normalization vs. Input Amplitude at 3.6 GHz for at Least 70 Devices, $R_{TADJ} = 51\ \Omega$

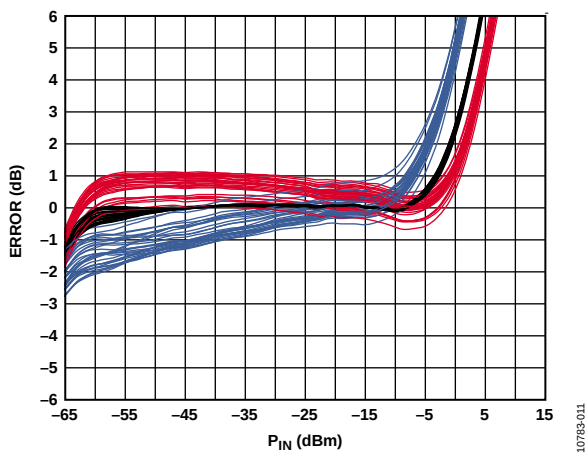


Figure 11. Distribution of Error at Temperature After Ambient Normalization vs. Input Amplitude at 1900 MHz for at Least 70 Devices

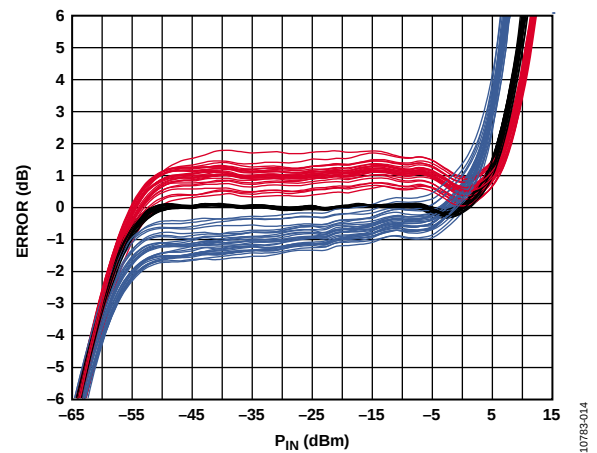


Figure 14. Distribution of Error at Temperature After Ambient Normalization vs. Input Amplitude at 5.8 GHz for at Least 70 Devices, $R_{TADJ} = 1000\ \Omega$

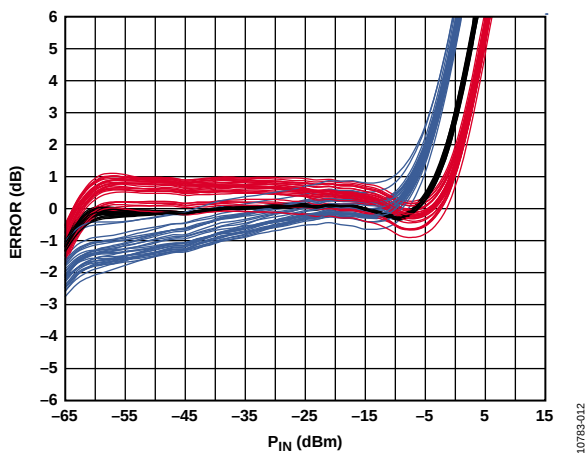


Figure 12. Distribution of Error at Temperature After Ambient Normalization vs. Input Amplitude at 2.2 GHz for at Least 70 Devices

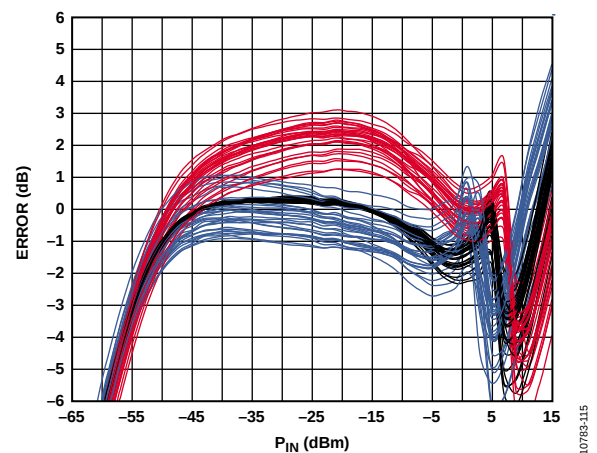


Figure 15. Distribution of Error at Temperature After Ambient Normalization vs. Input Amplitude at 8 GHz for at Least 70 Devices

$V_{POS} = 5\text{ V}$; $T_A = +25^\circ\text{C}$, -55°C , $+105^\circ\text{C}$; $C_{LPF} = 220\text{ pF}$; $R_{TADJ} = 500\ \Omega$; unless otherwise noted. Colors: $+25^\circ\text{C} \rightarrow$ Black; $-55^\circ\text{C} \rightarrow$ Blue; $+105^\circ\text{C} \rightarrow$ Red.

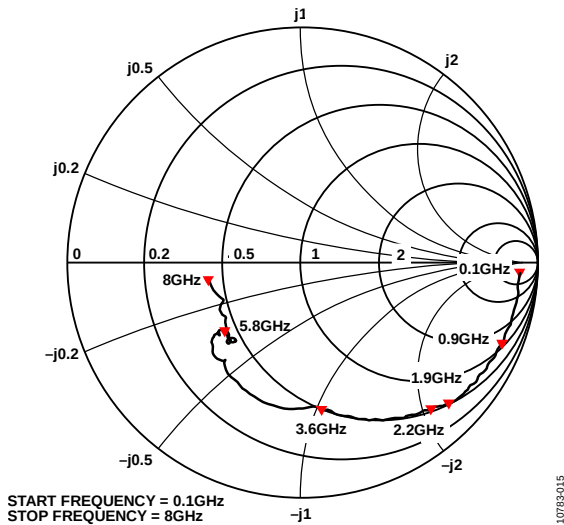


Figure 16. Input Impedance vs. Frequency; No Termination Resistor on INHI, $Z_0 = 50\ \Omega$

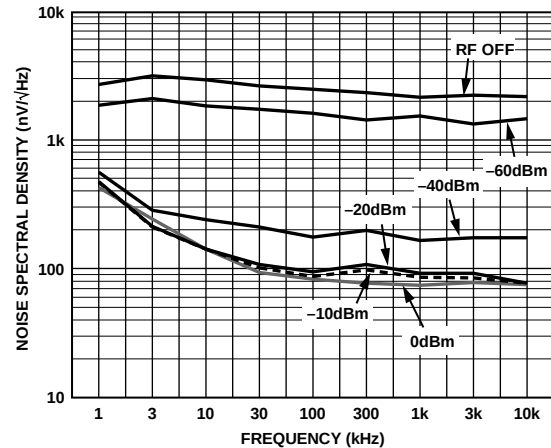


Figure 19. Noise Spectral Density of Output; CLPF = Open

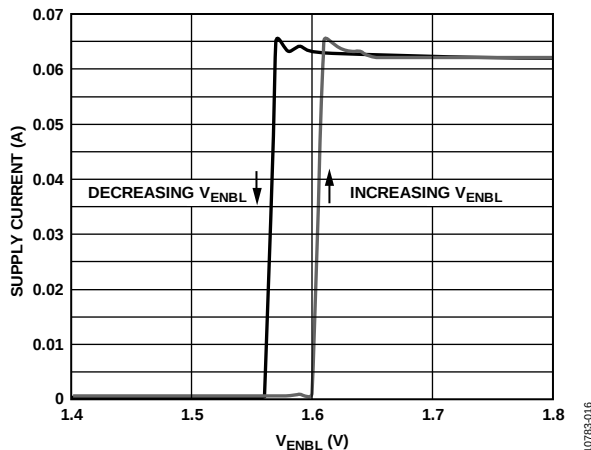


Figure 17. Supply Current vs. Enable Voltage

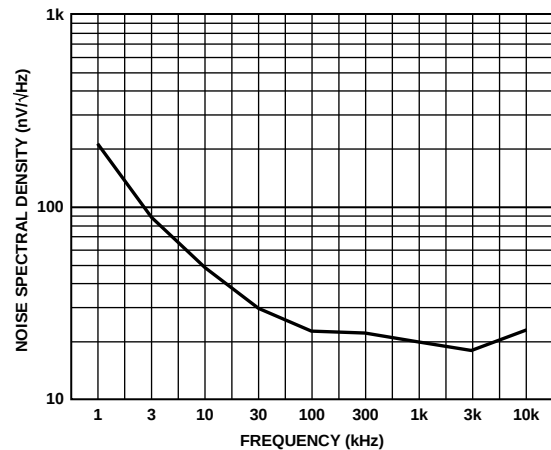


Figure 20. Noise Spectral Density of Output Buffer (from CLPF to VOUT); CLPF = $0.1\ \mu\text{F}$

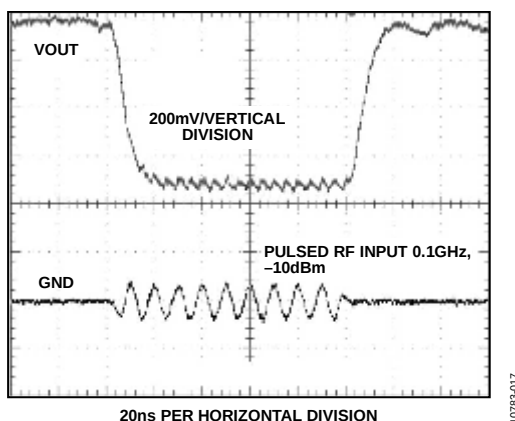


Figure 18. VOUT Pulse Response Time; Pulsed RF Input 0.1 GHz, -10 dBm ; CLPF = Open

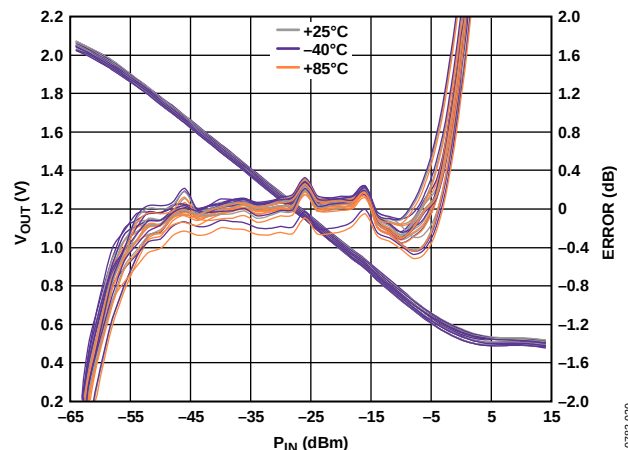
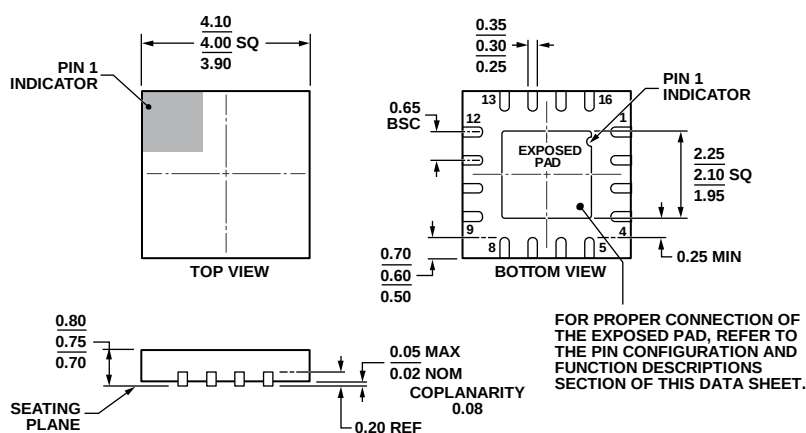


Figure 21. Output Voltage Stability vs. Supply Voltage at 1.9 GHz When VP Varies by 10%, Multiple Devices

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WGGC.

Figure 22. 16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]
4 mm × 4 mm Body, Very Very Thin Quad
(CP-16-23)
Dimensions shown in millimeters

111398-A

ORDERING GUIDE

Model ^{1, 2}	Temperature Range	Package Description	Package Option	Ordering Quantity
AD8318SCPZ-EP-RL7	–55°C to +105°C	16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]	CP-16-23	1,500
AD8318SCPZ-EP-R2	–55°C to +105°C	16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]	CP-16-23	250
AD8318SCPZ-EP-WP	–55°C to +105°C	16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]	CP-16-23	64
AD8318-EP-EVALZ		Evaluation Board		

¹ Z = RoHS Compliant Part.

² WP = waffle pack.

NOTES